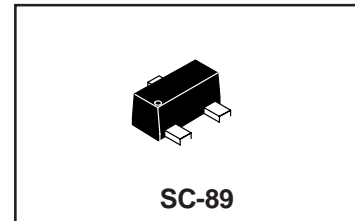


# Bias Resistor Transistors

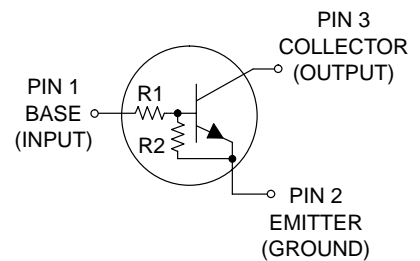
## NPN Silicon Surface Mount Transistors with Monolithic Bias Resistor Network

### LDTC114EET1G Series S-LDTC114EET1G Series

This new series of digital transistors is designed to replace a single device and its external resistor bias network. The BRT (Bias Resistor Transistor) contains a single transistor with a monolithic bias network consisting of two resistors; a series base resistor and a base-emitter resistor. The BRT eliminates these individual components by integrating them into a single device. The use of a BRT can reduce both system cost and board space. The device is housed in the SC-89 package which is designed for low power surface mount applications.



- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- The SC-89 package can be soldered using wave or reflow. The modified gull-winged leads absorb thermal stress during soldering eliminating the possibility of damage to the die.
- We declare that the material of product compliance with RoHS requirements.
- S- Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.



#### MAXIMUM RATINGS (T<sub>A</sub> = 25°C unless otherwise noted)

| Rating                    | Symbol           | Value | Unit |
|---------------------------|------------------|-------|------|
| Collector-Base Voltage    | V <sub>CBO</sub> | 50    | Vdc  |
| Collector-Emitter Voltage | V <sub>CEO</sub> | 50    | Vdc  |
| Collector Current         | I <sub>C</sub>   | 100   | mAdc |

#### THERMAL CHARACTERISTICS

| Rating  | Symbol                            | Value       | Unit        |
|---|-----------------------------------|-------------|-------------|
| Total Device Dissipation,<br>FR-4 Board (Note 1) @ T <sub>A</sub> = 25°C<br>Derate above 25°C | P <sub>D</sub>                    | 200<br>1.6  | mW<br>mW/°C |
| Thermal Resistance,<br>Junction-to-Ambient (Note 1)   | R <sub>θJA</sub>                  | 600         | °C/W        |
| Total Device Dissipation,<br>FR-4 Board (Note 2) @ T <sub>A</sub> = 25°C<br>Derate above 25°C | P <sub>D</sub>                    | 300<br>2.4  | mW<br>mW/°C |
| Thermal Resistance,<br>Junction-to-Ambient (Note 2)   | R <sub>θJA</sub>                  | 400         | °C/W        |
| Junction and Storage Temperature<br>Range   | T <sub>J</sub> , T <sub>stg</sub> | -55 to +150 | °C          |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. FR-4 @ Minimum Pad
2. FR-4 @ 1.0 × 1.0 Inch Pad

## LDTTC114EET1G Series;S-LDTTC114EET1G Series

### ORDERING INFORMATION AND RESISTOR VALUES

| Device                        | Marking | R1 (K) | R2 (K) | Package | Shipping <sup>†</sup> |
|-------------------------------|---------|--------|--------|---------|-----------------------|
| LDTTC114EET1G S-LDTTC114EET1G | 8A      | 10     | 10     | SC-89   | 3000 Tape & Reel      |
| LDTTC124EET1G S-LDTTC124EET1G | 8B      | 22     | 22     | SC-89   | 3000 Tape & Reel      |
| LDTTC144EET1G S-LDTTC144EET1G | 8C      | 47     | 47     | SC-89   | 3000 Tape & Reel      |
| LDTTC114YET1G S-LDTTC114YET1G | 8D      | 10     | 47     | SC-89   | 3000 Tape & Reel      |
| LDTTC114TET1G S-LDTTC114TET1G | 94      | 10     | ∞      | SC-89   | 3000 Tape & Reel      |
| LDTTC143TET1G S-LDTTC143TET1G | 8F      | 4.7    | ∞      | SC-89   | 3000 Tape & Reel      |
| LDTTC123EET1G S-LDTTC123EET1G | 8H      | 2.2    | 2.2    | SC-89   | 3000 Tape & Reel      |
| LDTTC143EET1G S-LDTTC143EET1G | 8J      | 4.7    | 4.7    | SC-89   | 3000 Tape & Reel      |
| LDTTC143ZET1G S-LDTTC143ZET1G | 8K      | 4.7    | 47     | SC-89   | 3000 Tape & Reel      |
| LDTTC124XET1G S-LDTTC124XET1G | 8L      | 22     | 47     | SC-89   | 3000 Tape & Reel      |
| LDTTC123JET1G S-LDTTC123JET1G | 8M      | 2.2    | 47     | SC-89   | 3000 Tape & Reel      |
| LDTTC115EET1G S-LDTTC115EET1G | 8N      | 100    | 100    | SC-89   | 3000 Tape & Reel      |
| LDTTC144WET1G S-LDTTC144WET1G | 8P      | 47     | 22     | SC-89   | 3000 Tape & Reel      |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

### ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted)

| Characteristic   | Symbol               | Min | Typ | Max  | Unit |
|--|----------------------|-----|-----|------|------|
| <b>OFF CHARACTERISTICS</b>   |                      |     |     |      |      |
| Collector-Base Cutoff Current (V <sub>CB</sub> = 50 V, I <sub>E</sub> = 0)                 | I <sub>CBO</sub>     | -   | -   | 100  | nAdc |
| Collector-Emitter Cutoff Current (V <sub>CE</sub> = 50 V, I <sub>B</sub> = 0)              | I <sub>CEO</sub>     | -   | -   | 500  | nAdc |
| Emitter-Base Cutoff Current (V <sub>EB</sub> = 6.0 V, I <sub>C</sub> = 0)                  | I <sub>EBO</sub>     | -   | -   | 0.5  | mAdc |
|  | LDTTC114EET1G        | -   | -   | 0.2  |      |
|  | LDTTC124EET1G        | -   | -   | 0.1  |      |
|  | LDTTC144EET1G        | -   | -   | 0.2  |      |
|  | LDTTC114YET1G        | -   | -   | 0.9  |      |
|  | LDTTC114TET1G        | -   | -   | 1.9  |      |
|  | LDTTC143TET1G        | -   | -   | 2.3  |      |
|  | LDTTC123EET1G        | -   | -   | 1.5  |      |
|  | LDTTC143EET1G        | -   | -   | 0.18 |      |
|  | LDTTC143ZET1G        | -   | -   | 0.13 |      |
|  | LDTTC124XET1G        | -   | -   | 0.2  |      |
|  | LDTTC123JET1G        | -   | -   | 0.05 |      |
|  | LDTTC115EET1G        | -   | -   | 0.13 |      |
|  | LDTTC144WET1G        | -   | -   |      |      |
| Collector-Base Breakdown Voltage (I <sub>C</sub> = 10 μA, I <sub>E</sub> = 0)              | V <sub>(BR)CBO</sub> | 50  | -   | -    | Vdc  |
| Collector-Emitter Breakdown Voltage (Note 3) (I <sub>C</sub> = 2.0 mA, I <sub>B</sub> = 0) | V <sub>(BR)CEO</sub> | 50  | -   | -    | Vdc  |

## LDTC114EET1G Series;S-LDTC114EET1G Series

| Characteristic  | Symbol   | Min           | Typ   | Max  | Unit  |     |
|---|--|---------------|---|--|---|-----|
| <b>ON CHARACTERISTICS</b> (Note 3)  |  |               |   |  |   |     |
| DC Current Gain<br>( $V_{CE} = 10\text{ V}$ , $I_C = 5.0\text{ mA}$ )   | LDTC114EET1G<br>LDTC124EET1G<br>LDTC144EET1G<br>LDTC114YET1G<br>LDTC114TET1G<br>LDTC143TET1G<br>LDTC123EET1G<br>LDTC143EET1G<br>LDTC143ZET1G<br>LDTC124XET1G<br>LDTC123JET1G<br>LDTC115EET1G<br>LDTC144WET1G | $h_{FE}$      | 35<br>60<br>80<br>80<br>160<br>160<br>8.0<br>15<br>80<br>80<br>80<br>80<br>80 | 60<br>100<br>140<br>140<br>350<br>350<br>15<br>30<br>200<br>150<br>140<br>150<br>140 | –<br>–<br>–<br>–<br>–<br>–<br>–<br>–<br>–<br>–<br>–<br>–<br>–                           |     |
| Collector–Emitter Saturation Voltage ( $I_C = 10\text{ mA}$ , $I_B = 0.3\text{ mA}$ )<br>( $I_C = 10\text{ mA}$ , $I_B = 5\text{ mA}$ ) LDTC123EET1G<br>( $I_C = 10\text{ mA}$ , $I_B = 1\text{ mA}$ ) LDTC143TET1G/LDTC114TET1G/<br>LDTC143EET1G/LDTC143ZET1G/LDTC124XET1G   |  | $V_{CE(sat)}$ | –   | –  | 0.25  | Vdc |
| Output Voltage (on)<br>( $V_{CC} = 5.0\text{ V}$ , $V_B = 2.5\text{ V}$ , $R_L = 1.0\text{ k}\Omega$ )<br><br>( $V_{CC} = 5.0\text{ V}$ , $V_B = 3.5\text{ V}$ , $R_L = 1.0\text{ k}\Omega$ )<br>( $V_{CC} = 5.0\text{ V}$ , $V_B = 5.5\text{ V}$ , $R_L = 1.0\text{ k}\Omega$ )<br>( $V_{CC} = 5.0\text{ V}$ , $V_B = 4.0\text{ V}$ , $R_L = 1.0\text{ k}\Omega$ ) | LDTC114EET1G<br>LDTC124EET1G<br>LDTC114YET1G<br>LDTC114TET1G<br>LDTC143TET1G<br>LDTC123EET1G<br>LDTC143EET1G<br>LDTC143ZET1G<br>LDTC124XET1G<br>LDTC123JET1G<br>LDTC144EET1G<br>LDTC115EET1G<br>LDTC144WET1G | $V_{OL}$      | –<br>–<br>–<br>–<br>–<br>–<br>–<br>–<br>–<br>–<br>–<br>–<br>–                 | –<br>–<br>–<br>–<br>–<br>–<br>–<br>–<br>–<br>–<br>–<br>–<br>–                        | 0.2<br>0.2<br>0.2<br>0.2<br>0.2<br>0.2<br>0.2<br>0.2<br>0.2<br>0.2<br>0.2<br>0.2<br>0.2 | Vdc |
| Output Voltage (off) ( $V_{CC} = 5.0\text{ V}$ , $V_B = 0.5\text{ V}$ , $R_L = 1.0\text{ k}\Omega$ )<br>( $V_{CC} = 5.0\text{ V}$ , $V_B = 0.25\text{ V}$ , $R_L = 1.0\text{ k}\Omega$ )  | LDTC143TET1G<br>LDTC143ZET1G<br>LDTC114TET1G<br>LDTC115EET1G   | $V_{OH}$      | 4.9   | –  | –   | Vdc |

3. Pulse Test: Pulse Width < 300  $\mu\text{s}$ , Duty Cycle < 2.0%

### ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted) (Continued)

| Characteristic   | Symbol    | Min   | Typ  | Max   | Unit       |
|--|-----------|---|--|---|------------|
| Input Resistor<br>LDTC114EET1G<br>LDTC124EET1G<br>LDTC144EET1G<br>LDTC114YET1G<br>LDTC114TET1G<br>LDTC143TET1G<br>LDTC123EET1G<br>LDTC143EET1G<br>LDTC143ZET1G<br>LDTC124XET1G<br>LDTC123JET1G<br>LDTC115EET1G<br>LDTC144WET1G | R1        | 7.0<br>15.4<br>32.9<br>7.0<br>7.0<br>3.3<br>1.5<br>3.3<br>3.3<br>15.4<br>1.54<br>70<br>32.9 | 10<br>22<br>47<br>10<br>10<br>4.7<br>2.2<br>4.7<br>4.7<br>22<br>2.2<br>100<br>47 | 13<br>28.6<br>61.1<br>13<br>13<br>6.1<br>2.9<br>6.1<br>6.1<br>28.6<br>2.86<br>130<br>61.1 | k $\Omega$ |
| Resistor Ratio<br>LDTC114EET1G/LDTC124EET1G/<br>LDTC144EET1G/LDTC115EET1G<br>LDTC114YET1G<br>LDTC143TET1G/LDTC114TET1G<br>LDTC123EET1G/LDTC143EET1G<br>LDTC143ZET1G<br>LDTC124XET1G<br>LDTC123JET1G<br>LDTC144WET1G            | $R_1/R_2$ | 0.8<br>0.17<br>–<br>0.8<br>0.055<br>0.38<br>0.038<br>1.7                                    | 1.0<br>0.21<br>–<br>1.0<br>0.1<br>0.47<br>0.047<br>2.1                           | 1.2<br>0.25<br>–<br>1.2<br>0.185<br>0.56<br>0.056<br>2.6                                  |            |

# LDTTC114EET1G Series;S-LDTTC114EET1G Series

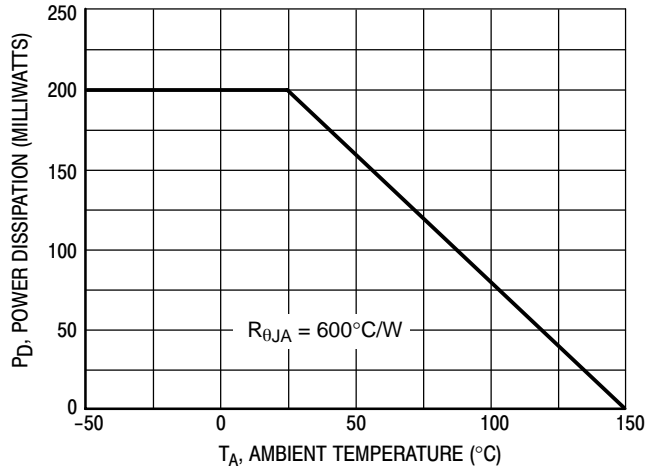


Figure 1. Derating Curve

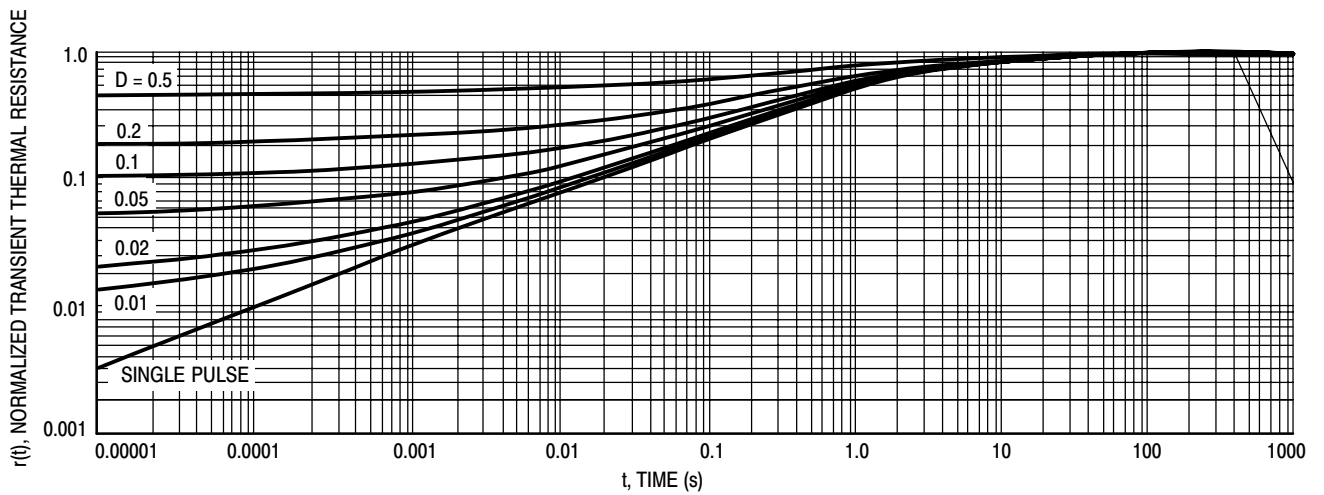


Figure 2. Normalized Thermal Response

# LDT C114EET1G Series; S-LDT C114EET1G Series

## TYPICAL ELECTRICAL CHARACTERISTICS – LDT C114EET1G

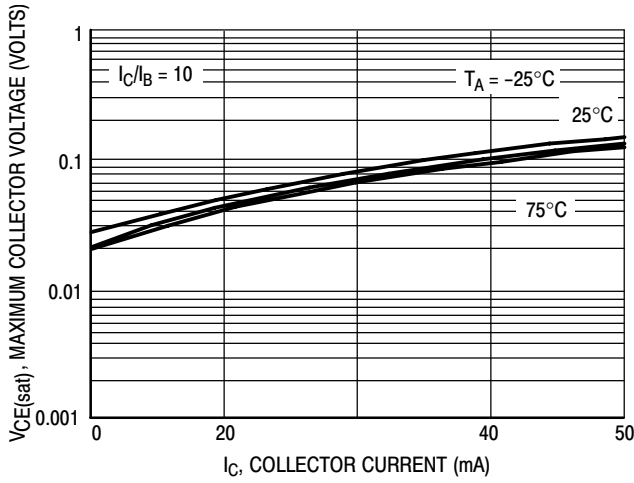


Figure 3.  $V_{CE(sat)}$  versus  $I_C$

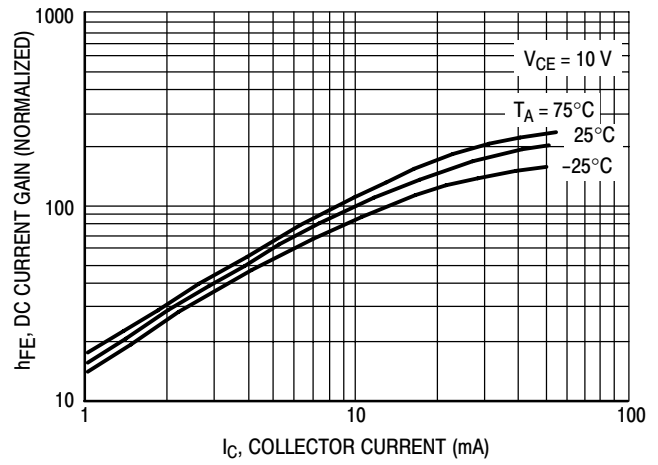


Figure 4. DC Current Gain

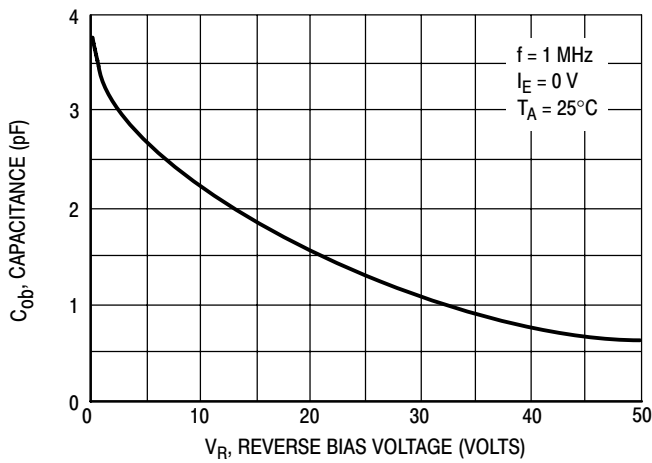


Figure 5. Output Capacitance

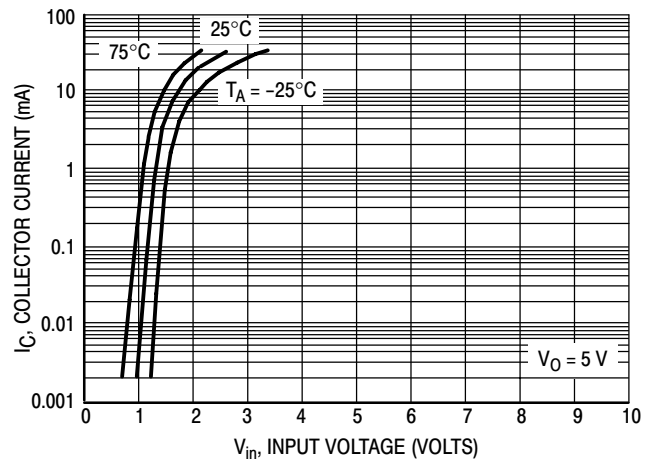


Figure 6. Output Current versus Input Voltage

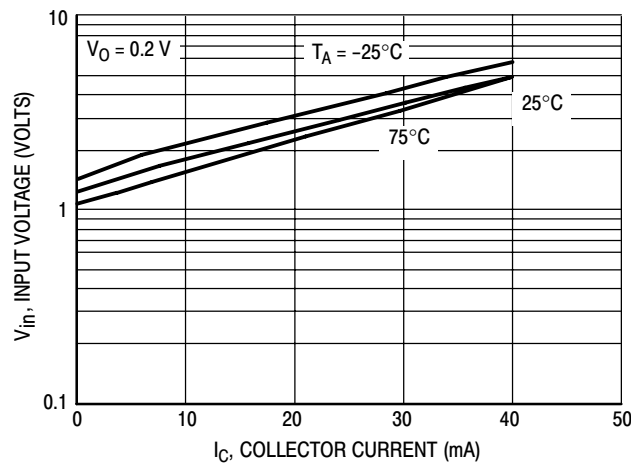


Figure 7. Input Voltage versus Output Current

# LDT C114EET1G Series; S-LDT C114EET1G Series

## TYPICAL ELECTRICAL CHARACTERISTICS – LDT C123EET1G

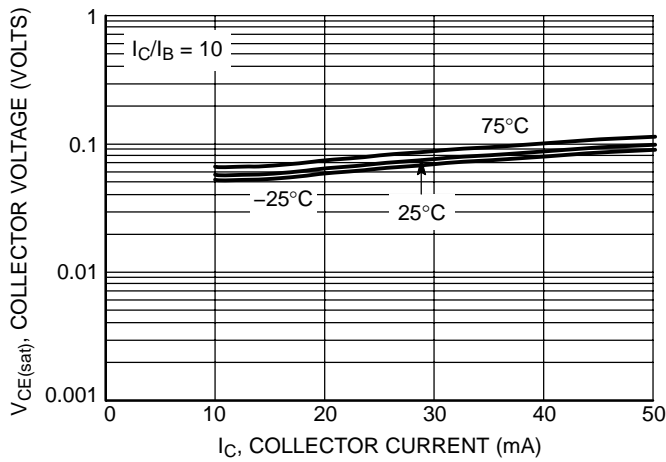


Figure 8.  $V_{CE(sat)}$  versus  $I_C$

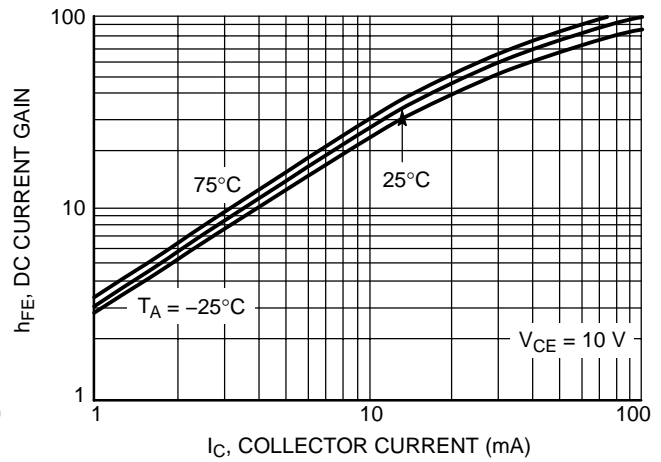


Figure 9. DC Current Gain

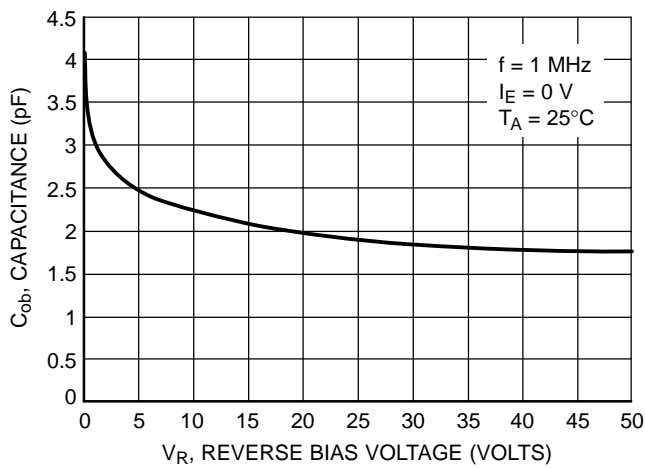


Figure 10. Output Capacitance

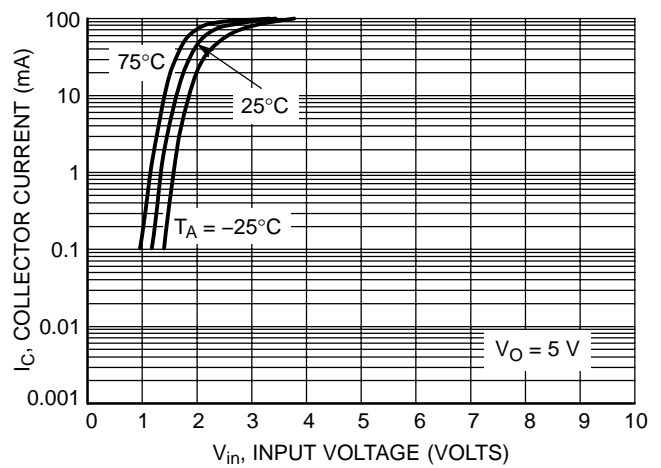


Figure 11. Output Current versus Input Voltage

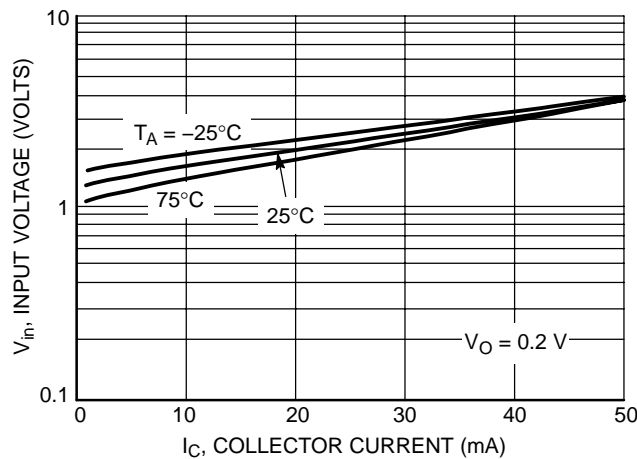


Figure 12. Input Voltage versus Output Current

# LDTC114EET1G Series; S-LDTC114EET1G Series

## TYPICAL ELECTRICAL CHARACTERISTICS – LDTC124EET1G

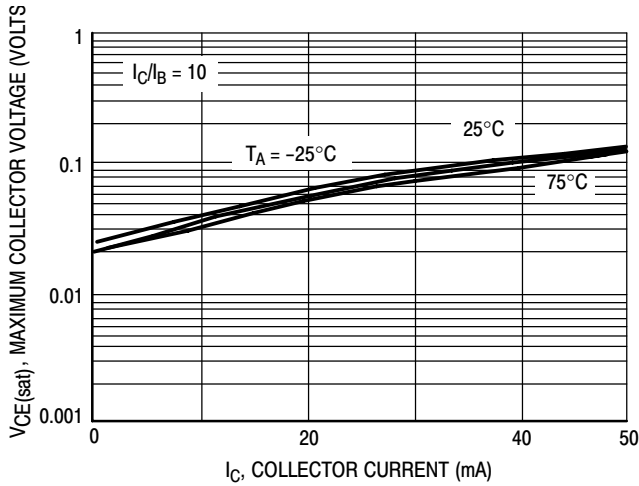


Figure 13.  $V_{CE(sat)}$  versus  $I_C$

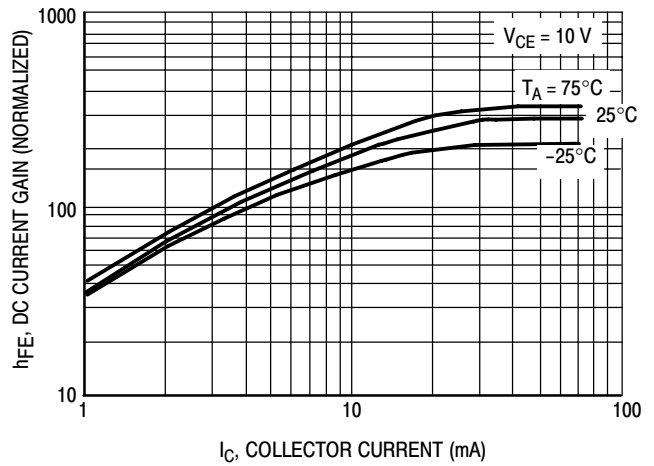


Figure 14. DC Current Gain

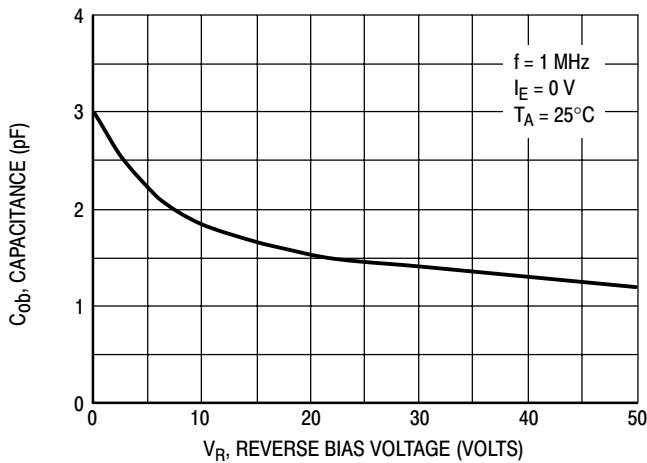


Figure 15. Output Capacitance

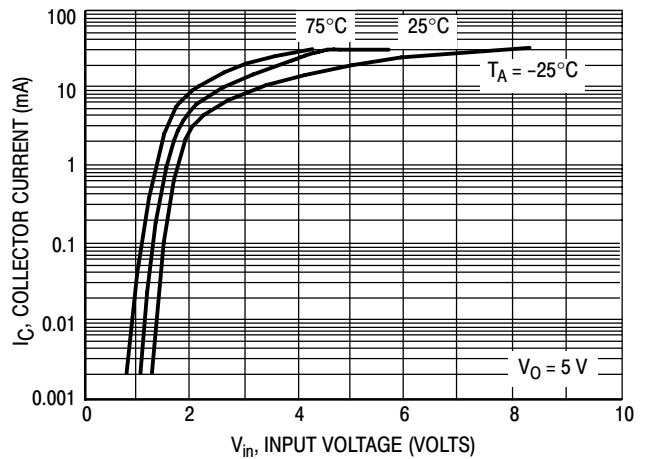


Figure 16. Output Current versus Input Voltage

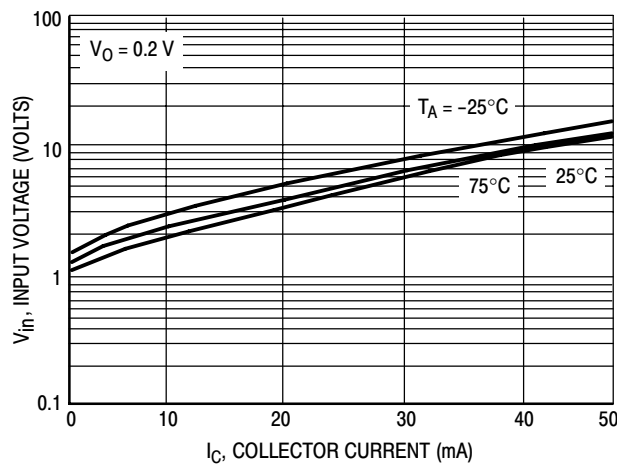


Figure 17. Input Voltage versus Output Current

# LDTc114EET1G Series; S-LDTc114EET1G Series

## TYPICAL ELECTRICAL CHARACTERISTICS – LDTc144EET1G

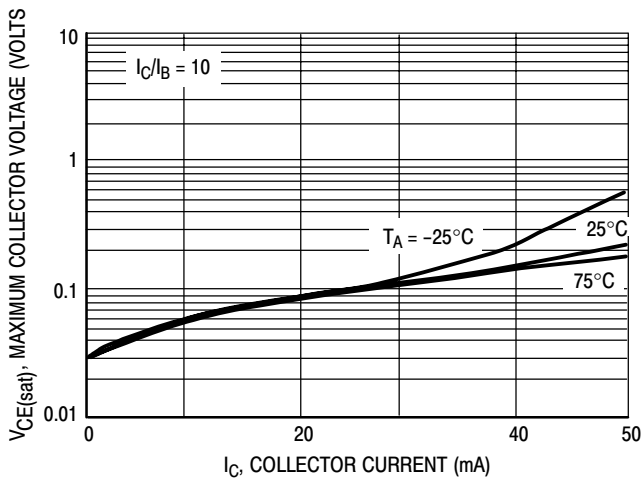


Figure 18.  $V_{CE(sat)}$  versus  $I_C$

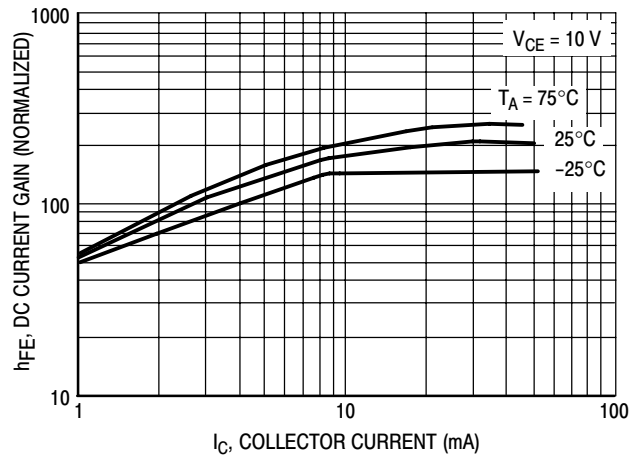


Figure 19. DC Current Gain

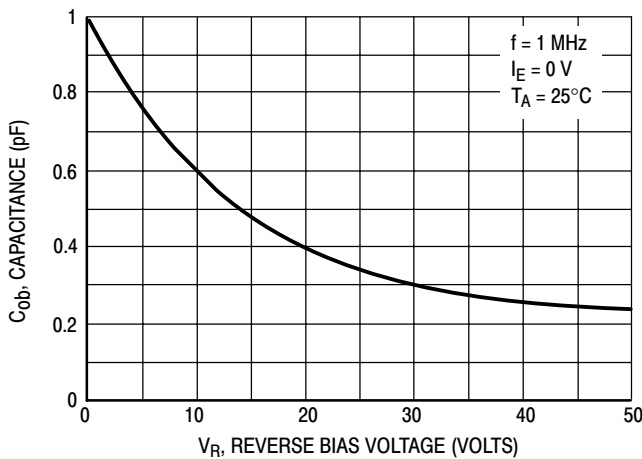


Figure 20. Output Capacitance

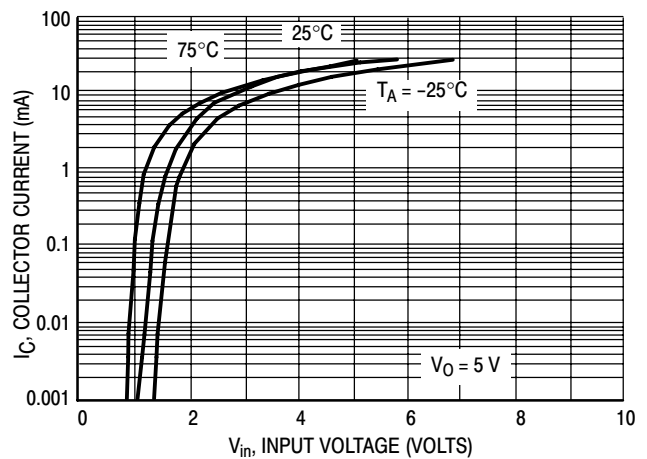


Figure 21. Output Current versus Input Voltage

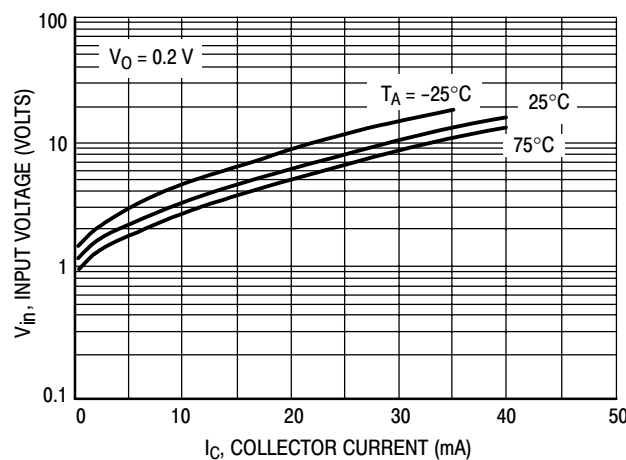


Figure 22. Input Voltage versus Output Current



# LDT C114EET1G Series; S-LDT C114EET1G Series

## TYPICAL ELECTRICAL CHARACTERISTICS – LDT C114YET1G

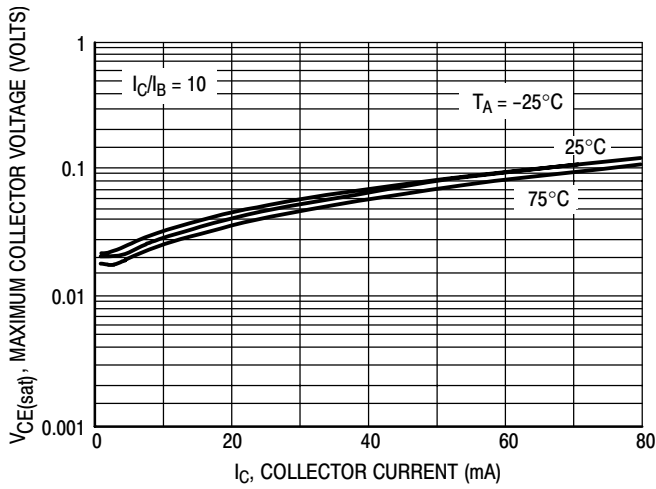


Figure 23.  $V_{CE(sat)}$  versus  $I_C$

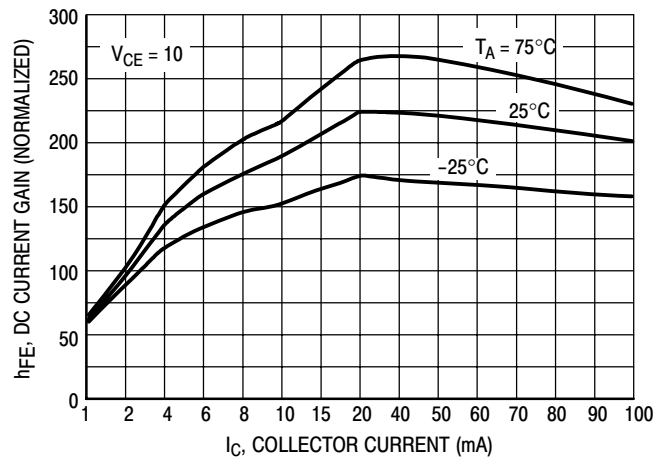


Figure 24. DC Current Gain

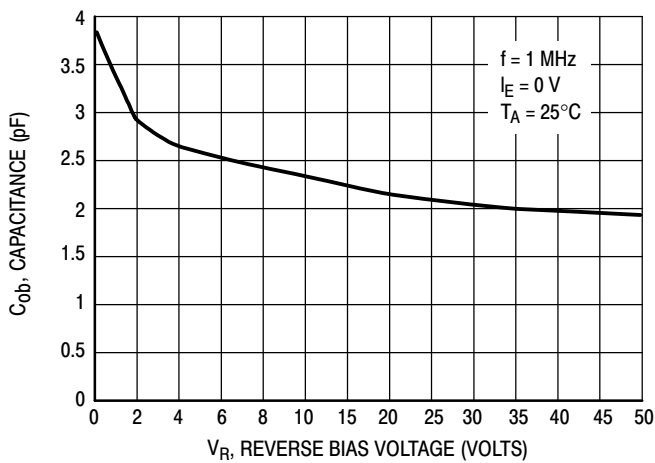


Figure 25. Output Capacitance

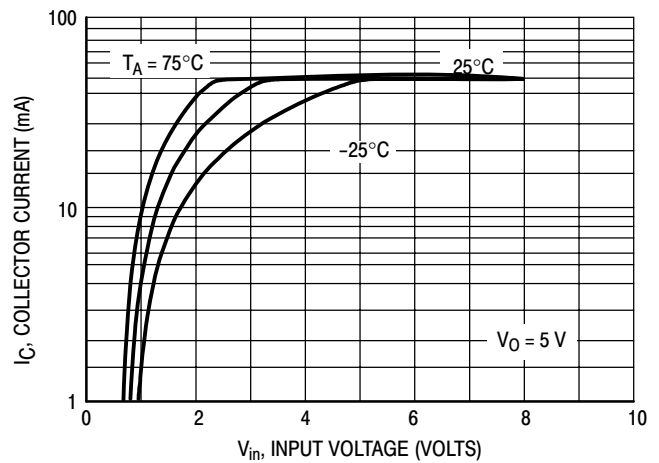


Figure 26. Output Current versus Input Voltage

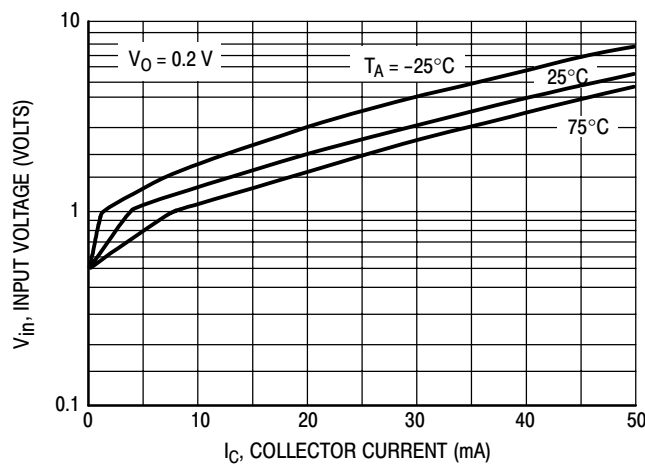


Figure 27. Input Voltage versus Output Current

# LDTc114EET1G Series; S-LDTc114EET1G Series

## TYPICAL APPLICATIONS FOR NPN BRTs

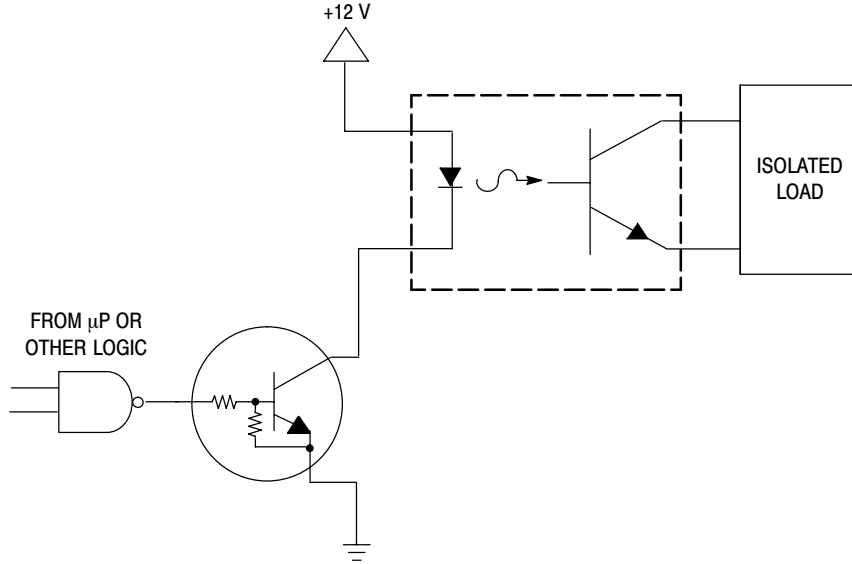


Figure 28. Level Shifter: Connects 12 or 24 Volt Circuits to Logic

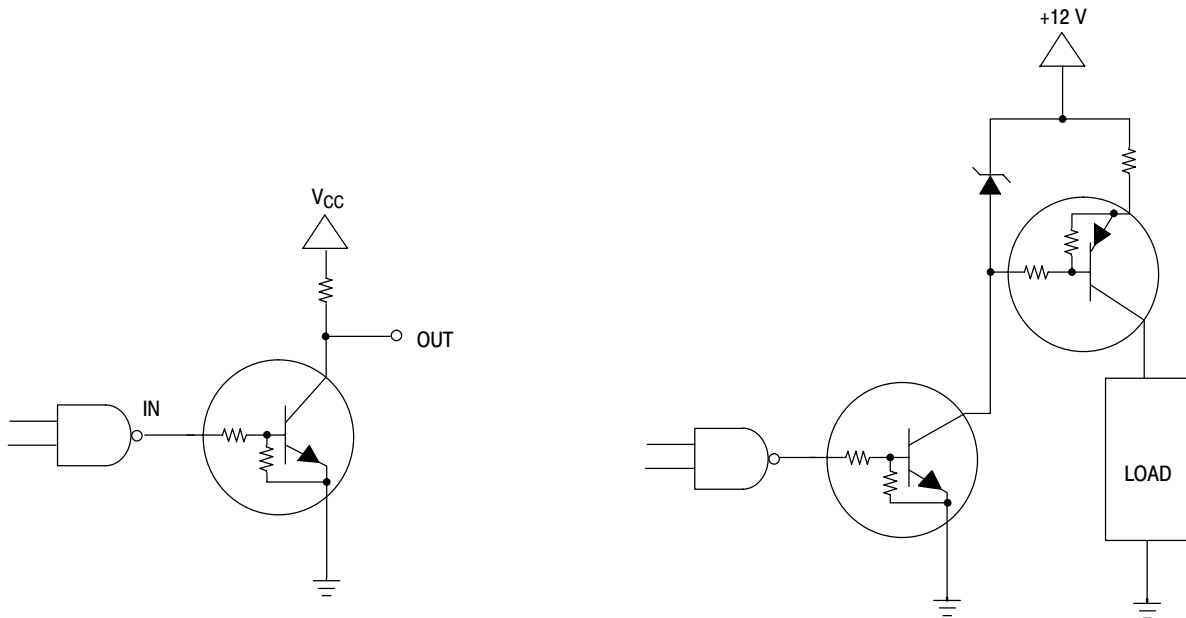
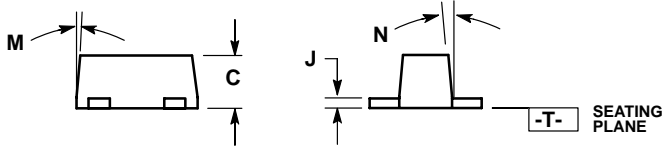
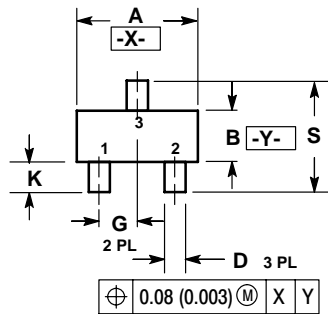


Figure 29. Open Collector Inverter: Inverts the Input Signal

Figure 30. Inexpensive, Unregulated Current Source

# LDTTC114EET1G Series;S-LDTTC114EET1G Series

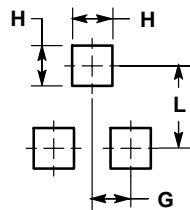
SC-89



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETERS
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. 463C-01 OBSOLETE, NEW STANDARD 463C-02.

| DIM | MILLIMETERS |      |      | INCHES    |       |       |
|-----|-------------|------|------|-----------|-------|-------|
|     | MIN         | NOM  | MAX  | MIN       | NOM   | MAX   |
| A   | 1.50        | 1.60 | 1.70 | 0.059     | 0.063 | 0.067 |
| B   | 0.75        | 0.85 | 0.95 | 0.030     | 0.034 | 0.040 |
| C   | 0.60        | 0.70 | 0.80 | 0.024     | 0.028 | 0.031 |
| D   | 0.23        | 0.28 | 0.33 | 0.009     | 0.011 | 0.013 |
| G   | 0.50 BSC    |      |      | 0.020 BSC |       |       |
| H   | 0.53 REF    |      |      | 0.021 REF |       |       |
| J   | 0.10        | 0.15 | 0.20 | 0.004     | 0.006 | 0.008 |
| K   | 0.30        | 0.40 | 0.50 | 0.012     | 0.016 | 0.020 |
| L   | 1.10 REF    |      |      | 0.043 REF |       |       |
| M   | ---         | ---  | 10 ° | ---       | ---   | 10 °  |
| N   | ---         | ---  | 10 ° | ---       | ---   | 10 °  |
| S   | 1.50        | 1.60 | 1.70 | 0.059     | 0.063 | 0.067 |



RECOMMENDED PATTERN OF SOLDER PADS